# 504770582 02/08/2018

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
AKHIL SRINIVASAN	02/02/2018
YIFEI WANG	02/02/2018

### **RECEIVING PARTY DATA**

Name:	MEDTRONIC MINIMED, INC.
Street Address:	18000 DEVONSHIRE STREET
City:	NORTHRIDGE
State/Country:	CALIFORNIA
Postal Code:	91325-1219

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15892172

## **CORRESPONDENCE DATA**

**Fax Number:** (310)641-8798

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Correspondent Name: GERARD B. SERAPIGLIA
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ATTORNEY DOCKET NUMBER:	130.148-US-01
NAME OF SUBMITTER:	GERARD B. SERAPIGLIA
SIGNATURE:	/GERARD B. SERAPIGLIA/
DATE SIGNED:	02/08/2018

#### **Total Attachments: 3**

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PATENT 504770582 REEL: 044875 FRAME: 0832

#### **ASSIGNMENT**

Attorney Docket No.: **G&C 130.148-US-01** 

(1-2)	Insert	Name(s)	of
Inven	tor(s)		

- (1) AKHIL SRINIVASAN
- (2) YIFEI WANG

In consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the undersigned (the receipt of which is hereby acknowledged), the undersigned agree(s) to assign, and hereby does assign, transfer, sell and set over to

- (3) Insert name of Assignee
- (3) MEDTRONIC MINIMED, INC.
- (4) Insert state of Incorporation of Assignee
- (4) Delaware
- (5) Insert address of Assignee
- (5) of 18000 Devonshire Street, Northridge, CA 91325-1219 (hereinafter designated as the Assignee), its successors and assigns, the entire worldwide right, title and interest in the invention (and any and all applications and all patents which may be granted on the invention) known as
- (6) Insert identification of Invention, such as Title, Case Number or Foreign Application Number
- (6) METHODS FOR CONTROLLING PHYSICAL VAPOR DEPOSITION METAL FILM ADHESION TO SUBSTRATES AND SURFACES

for which the undersigned has (have) executed an application for patent in the United States of America as the inventor (inventors)

- (7) Insert Date of Signing of Application
- (7) on <u>February</u> 2,2018

For the aforementioned consideration, the undersigned does (do) materially represent to the Assignee, its successors and assigns, that at the time of the execution of this assignment that the undersigned is (are) a lawful owner(s) of the entire right, title and interest in and to the invention and the above-identified application for patent, and that the same is unencumbered, and that the undersigned has (have) good right(s) and lawful authority to sell and convey the same in the manner set forth herein.

The undersigned further agree(s):

- a) to execute all papers necessary in connection with an application in any country of the world and any extension, reissue, reexamination, continuation-in-part, continuation or divisional applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient;
- b) to execute all papers necessary in connection with any interference which may be declared concerning this application or extension, reissue, reexamination, continuation-in-part, continuation or divisional applications thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference;
- c) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements (including the Patent Cooperation Treaty, Paris Convention, etc.) for any application filed in a foreign country claiming priority to the invention;
- d) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States Patent or other international application or foreign country patent to the Assignee;

Medtronic MiniMed Docket No.: C00017408.USU1

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	uthorize(s) and request(s) the Director		
issue any and all Letter:	s Patents of the United States resultin	ng from the application or any exter	nsion, reissue,
reexamination, continua	ation-in-part, continuation or divisional	applications thereof to the Assign	ee, as Assignee of
the entire right, title and	I interest in and to the same, and here	by covenants that he has (they ha	ve) full right to
convey the entire intere	st herein assigned, and that he has (t	hey have) full right to convey the e	ntire interest herein
assigned, and that he h	as (they have) not executed, any agre	eement in conflict herewith; and	

### f) to hereby appoint:

Paul H. Kovelman, Reg. No. 35,228 Eric S. Chen, Reg. No. 43,542 Alma P. Levy, Reg. No. 43,751 Sharon E. Mughal, Reg. No. 59,816 Ajit S. Narang, Reg. No. 55,480 Vivian S. Shin, Reg. No. 43,919

and all of the firm of Gates & Cooper LLP:

William J. Wood, Reg. No. 42,236 Gerard Serapiglia, Reg. No. 65,177

the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: _	2/2/18	Signature of Inventor (1):  Name of Inventor: AKHIL SRINIVASAN
Date: _	2/2/2018	Signature of Inventor (2):  Name of Inventor: YIFEI WANG

# ACCEPTANCE:

The undersigned, MEDTRONIC MINIME foregoing assignment.  SIGNED AND SEALED this day of	f. J. INC., a Delaware corporation, hereby declares that it has accepted the
	ASSIGNEE:
	MEDTRONIC MINIMED, INC., a Delaware Corporation  By:

Name: Paul H. Kovelman

Title: Chief Patent Counsel